

New Product Introduction



November 2019

HybridPack[™] Drive Performance

BGSA143GL10

LITIX[™] Basic+ TLD2252-2EP

Multi-MOSFET driver family – TLE92108

PROFET™+2 12 V Shields for Arduino for Heating and Power distribution

40 V StrongIRFET™ in symmetrical, dual SuperSO8

XENSIV[™] - New(!) Pressure 2GO kits

Infineon XMC 3-Channels RGB LED Lighting Shield

Infineon XMC1400 ARDUINO kit

650 V high and low current half-bridge SOI gate driver family

1200 V CoolSiC[™] discrete MOSFETs M1H portfolio extension

Integrated two-stage PFC + LLC/LCC resonant half-bridge controller

CoolSiC[™] MOSFET evaluation board for 7.5 kW motor drive

OPTIGA™ TRUST M SLS32AIA

OPTIREG[™] - TLS850F2TA V50

OPTIREG[™]- TLS715B0NA V50

HybridPack[™] Drive Performance

The HybridPACK[™] Drive Family offers 5 variants of power modules for main inverters with the newest two derivates being FS950R08A6P2B (950A/750V) and FS380R12A6T4B (380A/1200 V).

Other product versions include: 660 A /750 V , 770 A /750 V , 820 A /750 V (collector current and blocking voltage).

This module has an adapted baseplate structure for different cooling types. Flat baseplate without direct cooling structure, Pinfin for best cooling performance and Wave (Ribbon Bond) for a cost-efficient solution between low and high performance.

One gate driver PCB fits all module variants, keeping the same module footprint.

Features

Benefits

>

- FS950R08A6P2B: 750 V EDT2 IGBT for up to T_{vj} = 175°
 C switching operation
- > FS380R12A6T4B: 1200 V IGBT4 for up to T_{vj} = 175°C switching operation
- > Mechanical guiding elements for efficient and cost-saving inverter assembly and press-fit signal pins
- Benchmark IGBT chip with higher density and lower switching losses (FS950R08A6P2B only)
- > Very compact and cost efficient inverter designs
- > Reuse of existing package technology
- > Broad portfolio of modules for different performance classes

Quality, production capabilities, scalable performance and

> Support easy assembly processes

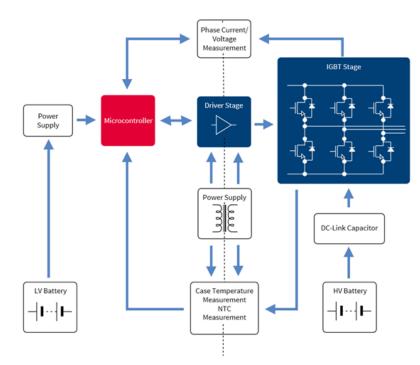
modular approach for design in

Competitive advantage

Target applications

> Main inverter for xEV

Block diagram



Product collaterals / Online support Product Family page Product Brief FS950 Product brief FS380 Application note Application Brochure

Product overview incl. data sheet link

OPN	SP Number	Package
FS950R08A6P2BBPSA1	SP001720776	AG-HYBRIDD-1-1
FS380R12A6T4BBPSA1	SP001632438	AG-HYBRIDD-1-1



BGSA143GL10

BGSA143GL10 is a small and versatile Single-Pole Quad Throw (SP4T) RF switch optimized for low C_{OFF} as well as low R_{ON} enabling applications up to 6.0GHz. GPIO digital control lines offer the possibility to adopt SP4T, SPDT along with SPST topology for an optimum flexibility in RF Front-end designs.

BGSA143GL10 is ideal for high Q tuning applications. This single supply chip integrates on-chip CMOS logic control. It can be driven by 2 or 3 CMOS or TTL compatible control input signals.

Features

- >~ Ultra low $R_{\mbox{\scriptsize ON}}$ resistance of 1.15 Ω at each port in ON state
- > $\;$ Low C_{\rm OFF} capacitance of 140 fF at each port in OFF state
- > High RF operating peak voltage handling of 42 V in OFF state
- > Resonance-Stopper Antenna Tuning
- > Low harmonic generation
- > 3 GPIO pins control interface
- > No RF parameter change within supply voltage range
- > Small form factor 1.1 x 1.5 mm² (MSL1, 260°C per
- JEDEC J-STD-020)
 RoHS and WEEE compliant package

Target applications

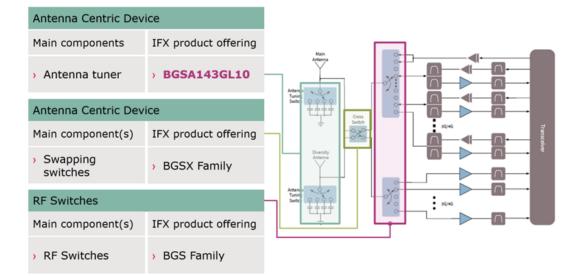
- > High-linearity antenna tuning switching
- > RF tuning applications

Benefits

- > Low cross-bands interference
- > Minimizes antenna tuning switch losses
- > Optimizes antenna efficiency and bandwidth
- Allows multiple selectable switch configurations (SP4T/SP3T/ SPDT/SPST)

Competitive advantage

> Eliminates unwanted resonance



Application Block Diagram for RF Front End in a Mobile Phone

Product overview incl. data sheet link

OPN	SP Number	Package
BGSA143GL10E6327XTSA1	SP003713658	PG-TSLP-10

Product collaterals / Online support

Proudct page



LITIX[™] Basic+ TLD2252-2EP

Extension product to LITIX[™] Basic+ family (7th family member)

The LITIX[™] Basic+ TLD2252-2EP is a dual channel high-side driver IC with integrated output stages. It is designed to control LEDs with a current up to 120 mA. In typical Automotive applications, the device is capable to drive 3 red LEDs per chain (in total 6 LEDs) with a current up to 100 mA and even above (if not limited by the overall system thermal properties). Practically, the output current is controlled by an external resistor or reference source, independently from load and supply voltage changes.

Features

Benefits

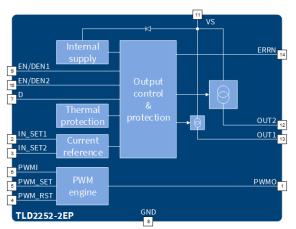
- Dual channel linear LED driver with integrated and protected output >stages (current sources)
- Asymmetric output stages (OUT1, OUT2) to enhance luminosity control for different functions: OUT1: 10 up to 120 mA; OUT2: 5 up to 60mA
- Independent output current's control via low power resistors and dedicated enable inputs (INSET1, INSET2, EN1, EN2)
- Output currents optimized for high current accuracy
- Integrated PWM engine supports digital dimming with very high ac-> curacy
- Intelligent fault management >
- Diagnosis enable (DEN1, DEN2) inputs integrated in enable function > (EN1, EN2)
- Delay input (D) for N-1 function
- Up to 16 devices can share a common error network with only one > external resistor

- External component need is reduced >
- **Direct PWM connection** >
- Shared ERRN network
- Shared DEN/EN network >
- Shared D/DS pin capacitor >
- Direct OUTSET and INSET connection >
- Low active error network >
- > Improved and precise diagnosis

Target applications

- Automotive LED exterior/rear lighting >
- Automotive LED interior lighting >
- Industrial LED lighting >

Block diagram



Product overview incl. data sheet link

OPN	SP Number	Package
TLD22522EPXUMA1	SP001604372	PG-TSDSO-14

Competitive advantage

- Member of the scalable LITIX[™] Basic+ family >
- Improved diagnosis >
- High current accuracy and broad current range >
- High PWM accuracy via integrated PWM engine
- Optimized EMC performance >

Product collaterals / Online support Product page Application note

Multi-MOSFET driver family – TLE92108 8x half-bridge drivers for automotive motor control applications

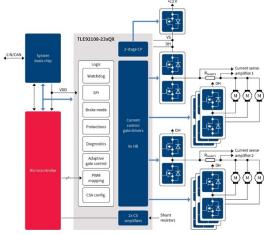
The TLE92108 is a family of multi-MOSFET driver ICs, designed to control up to eight half-bridges (up to 16 n-channel MOSFETs) with one packaged device. A 24-bit Serial Parallel Interface (SPI) enables configuration of the TLE92108 and is used to control the half-bridges. The SPI offers a wide range of diagnostic features such as the monitoring of the supply voltage, the charge pump voltage, temperature warning and over-temperature shutdown. Further, each gate driver monitors its external MOSFET drain-source voltage for hard-short circuit conditions, while the devices can observe the current passing through the integrated current sense amplifier providing configurable soft-short circuit detection, in both cases providing active latching hardware protection independent of any software measures.



Features

- 8-fold halfbridge (16 n-channel) MOSFET driver outputs
 3 PWM inputs
 - High-side and low-side PWM capable
 - Active free-wheeling
 - Up to 25 kHz PWM frequency
- > Adaptive multi-stage MOSFET gate control
- > Integrated dual stage charge pump supporting an external n-FET for reverse battery protection
- > 24-bit Serial Peripheral Interface
- > 2 x flexible current sense amplifiers (for HS, LS and in phase)
- Detailed off-state diagnostic as open load, short circuit to battery or to ground)
- > Drain-source monitoring for hard short circuit detection
 - Current sense monitoring for soft short circuit detection
 Overtemperature warning and shutdown
 - Overtemperature wa
 Timeout watchdog
- > Configurable motor brake mode also in sleep mode
- > Low current consumption in sleep mode (3 μ A)

Block diagram



Product overview incl. data sheet link / Product page

OPN	SP Number	Package
TLE92108231QXXUMA1	SP001635674	PG-VQFN-48
TLE92108232QXXUMA1	SP001635676	PG-VQFN-48
TLE9210823QXAPPKITTOBO1	SP004830802	Board

Benefits

- > Enable cost and board space improvements
- > Adaptive driver allows balancing of power dissipation vs. EMC performance, adjusts for MOSFET type and lot-to-lot variations
- > High configurability

Target applications

- Seat module and extended functions (steering column adjustment, gas pedal adjustment)
- > Closure systems (e.g. trunk opener, sliding door, sun-roof)
- > Central door lock
- > Body control module (cargo cover, washer pump, window lift, wiper)

Competitive advantage

- > Patented gate driver concept with multi stage self-adaption
- > Integrated current sense amplifier for HS, LS and in phase,
- Highest number of gate drivers integrated in one small device in the market
- > Detailed off-state diagnostic

Qualification

> AEC Q-100 qualified

Product collaterals / Online support Product Family page Product Brief Application note

PROFET[™]+2 12 V Shields for Arduino for Heating and Power distribution

The PROFET™+2 12 V shield for heating and power distribution applications is equipped with 4 BTS700*-1EPP high-side switches and compatible with Arduino. For demonstrating relay and fuse replacement, the shield can be used to control and protect outputs of a 12 V supply, turn ON/OFF loads, measure the load current and detect no-load condition. Infineon offers four different shields for Arduino: BTS7002-1EPP/ BTS7004-1EPP/ BTS7006-1EPP / BTS7008-1EPP.

Features

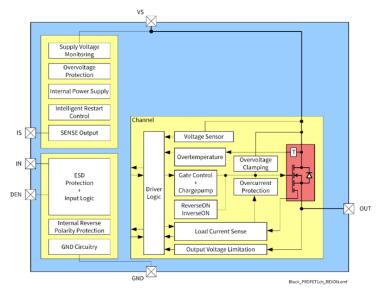
Benefits

- > Lowest $R_{DS(ON)}$ on small footprint $2m\Omega 8m\Omega$ in TSDSO-14
- > Protection concept with current trip and intelligent latch
- > Diagnosis with high current sense accuracy up to current trip level >
- > Optimized for design flexibility across the family by pin to pin and external components compatibility
- > Miniaturization / Shrink of the PCB Area

Target applications

- > Suitable for driving up to 20 A resistive, inductive, capacitive loads
- Replaces electromechanical relays, fuses and discrete circuits
- > Suitable for driving heating loads and general power distribution

Block diagram



Product overview incl. data sheet link / Product page

OPN	SP Number	Package
SHIELDBTS70021EPPTOBO1	SP005122308	PG TSDSO-14
SHIELDBTS70041EPPTOBO1	SP005122316	PG TSDSO-14
SHIELDBTS70061EPPTOBO1	SP005122324	PG TSDSO-14
SHIELDBTS70081EPPTOBO1	SP005122328	PG TSDSO-14

- > 50% reduced internal operating current consumption
- > Simplified & cost efficient ground network
- Current sense accuracy (kILIS) ≤ 5% @ nominal load current
- > Benchmark cranking voltage capability able to work down to 3.1 V

315

> Very low output leakage current ($\leq 0.5 \,\mu$ A up to 85° C)

Competitive advantage

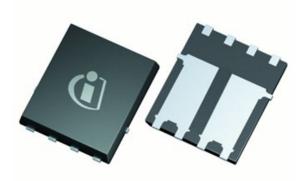
> Energy efficiency and miniaturization

Product collaterals / Online support
Product page
Product Brief
Application Brochure
Application note

40 V StrongIRFET™ in symmetrical, dual SuperSO8

The IRF40H233 (40 V, 6.2 mΩ, dual N-channel, SuperSO8) is a new addition to the StrongIRFET[™] power MOSFET family. By integrating two MOSFETs into a single package, the system power density is nearly double that of two single MOSFETs.

The IRF40H233 is designed for motor control applications such as brushed, BLDC, stepper, and servo motors.



Features

- > Symmetrical Dual MOSFET
- > Industry-standard footprint
- > Product qualification according to JEDEC standard
- Optimized for broadest availability from distribution partners

Benefits

- Cost- and space-saving solution compared to using a single power MOSFET with similar specifications and package
- > Increased robustness
- > Easy drop-in replacement
- > Industry standard qualification level
- > Multi-vendor compatibility

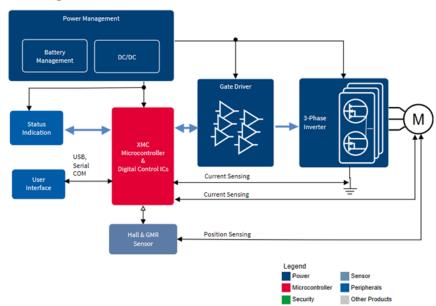
Competitive advantage

 The IRF40H233 dual MOSFET incorporates two symmetrical MOSFETs in a single package resulting in reduced system costs



- > Brushed motor
- > Brushless DC motor
- > Stepper motor
- > Servo motor

Block diagram



Product overview incl. data sheet link

OPN	SP Number	Package
IRF40H233XTMA1	SP001683272	DUAL PQFN 5X6 8L

Product collaterals / Online support
Product page
Product brief

XENSIV[™] - New(!) Pressure 2GO kits

Infineon's famous portfolio of XENSIV[™] Sensor 2GO kits gets expanded with new sensors. Just for you to recap: Infineon's 2GO kit family is a budget-priced evaluation board equipped with a sensor combined with an ARM® Cortex[™]-M0 CPU. The sensor 2GO kit has a complete set of on-board devices, including an on-board debugger. In addition a dedicated GUI supports a fast evaluation of the device. So far the family of 2GO kits is available for magnetic angle, 3D Hall as well magnetic current and speed sensors. We now enlarged and expanded the portfolio by our automotive BAP (barometric pressure) and MAP (manifold pressure) sensors which are comprised under our new XENSIV[™] Pressure Sensor 2GO kits. The new Pressure 2GO kits are available as analog and digital BAP as well as analog and digital BAP sensors.



Features

- > MAP and BAP sensors available in 2GO kit setup
- > Sensor and ARM® Cortex[™]-M0 CPU on one board
- Comprises pressure couple (with sealing) and pneumatic connector (4mm/6mm tube)
- > Fast evaluation
- > Ready-to-use GUI for 2GO kits
- > External NTC included for KPKP275-PS2GO-KIT

Target applications

- > MAP and BAP for automotive and industry
- > Automotive applications
- > Industrial control
- > Consumer applications
- > Medical applications
- > Weather stations
- > Altimeters

Benefits

- > Out of the box
- > Flexibility
- > Faster time to market
- > Ease of use
- > Fast prototyping
- > Simplicity

Competitive advantage

- > Ready-to-use kit including sensor and ARM® Cortex™-M0 CPU
- > Dedicated GUI enabling fast orientation and evaluation
- Fast start up via pressure couple (with sealing) and pneumatic connector (4mm/6mm tube)

Product overview incl. data sheet link

OPN	SP Number	Package
KP275PS2GOKITTOBO1	SP002676648	Board
KP215F1701PS2GOKITTOBO1	SP002676652	Board
KP229E3518PS2GOKITTOBO1	SP002676656	Board
KP254PS2GOKITTOBO1	SP002676660	Board
KP236PS2GOKITTOBO1	SP002676664	Board

Product collaterals / Online support

BAP & MAP 2GO kits overview MAP Pressure Sensor 2GO kit – KP215F1701 MAP Pressure Sensor 2GO kit - KP229E3518 XENSIV[™] – Sensor 2GO kits and Shield2Go Infineon for Makers – Shield2Go Overview Product brochure-Shield2Go Whitepaper for Shield2Go boards and My IoT adapter XENSIV[™] Automotive BAP and MAP sensors

Infineon XMC 3-Channels RGB LED Lighting Shield w/ XMC1302

The XMC 3 channels RGB LED Lighting Shield from Infineon technologies is one of the first intelligent evaluation boards compatible with Arduino as well as Infineon's XMC1100 BOOT KIT. It is designed to be easily configurable and combinable for different LED light engines and lamps, for fast prototyping and in-expensive evaluation of LED lighting applications. The RGB LED Lighting Shield with XMC1302 uses a DC/DC buck topology and is able to drive up to 3 LED channels with constant current. The shield itself is powered by a programmable XMC 32-bit ARM® MCU with embedded Brightness Color Control Unit (BCCU, XMC1300 MCU series), for flicker-free LED dimming and color control. The BCCU enables extreme low-cost but high quality LED lighting solutions, with minimal user code. The RGB LED lighting shield has also been designed to provide options for the evaluation of smooth, eye-friendly dimming, color mixing for different topologies, and it can be extended with for example DALI/DMX or radar.



Features

- Compatible with Arduino Uno R3 and XMC1100 Boot Kit from Infineon
- Easy configurable for various light engines and any input voltage (within operating conditions)
- > Wide DC input voltage range
- > Simple I²C interface
- > DALI and DMX interface
- Small size thanks to high-frequency current control (high power density)
- > Fast prototyping of 3 channels RGB LED lighting
- > Flicker-free light thanks to high-speed pulse density modulation
- > Easy-to-use dynamic dimming and color control

Competitive advantage

Block diagram

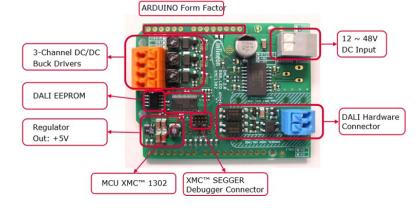
- Flicker-free light thanks to high-speed pulse density modulation (specific peripheral from XMC devices BCCU)
- Small size thanks to high-frequency current control (high power density)

Benefits

- > Fast prototyping of 3 channels RGB LED lighting
- > Flicker-free light thanks to high-speed pulse density modulation
- > Easy-to-use dynamic dimming and color control
- Small size thanks to high-frequency current control (high power density)
- Backdoor access to on-board-microcontroller for advanced users and parameterization (external debugger KIT XMC LINK SEGGER V1 needed)

Target applications

- > Cloud connected IoT devices
- > Building & industrial automation
- > EtherCAT slave controllers
- > LED lighting
 - > Home appliances
 - > Horticultural and indoor gardening



Product overview incl. product page link

OPN	SP Number	Package
KITXMCLEDDALI20RGBTOBO1	SP005324196	Board

Product collaterals / Online support Quick start guide

Infineon XMC1400 ARDUINO kit

Explore the most of our XMC1400 Microcontroller with the XMC1400 ARDUINO kit. This kit utilizes Infineon's industry leading ARM® Cortex®-M0 microcontroller in combination with ARDUINO form factor.

Focused on evaluate the capabilities of the XMC1400 Microcontroller multiple applications solutions, it can be used with a wide range of development tools including Infineon's free of charge Eclipse based IDE, DAVE[™] and much more.



Features

- > Compatible with ArduinoTM Uno R3
- > XMC1400 Cortex M0 microcontroller at 48MHz
- > Multiple applications configurations for lighting, motor control, power conversion and automation

Benefits

- > Powerful microcontroller XMC1400
- > ARDUINO[™] UNO compatibility
- > Flexibility
- > CAN connectivity
- > Debugger included

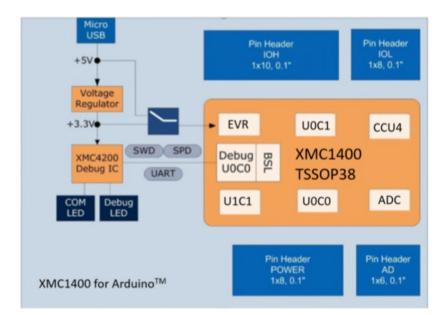
Competitive advantage

- > Powerful Microcontroller XMC1400
- > ARDUINO UNO compatibility
- > Flexibility
- > CAN connectivity
- > Optimized for motor control and Lighting

Target applications

- > Makers
- > Cloud connected IoT devices
- > Building & industrial automation
- > LED lighting
- > Home appliances

Block diagram



Product overview incl. data sheet link

OPN	SP Number	Package
KITXMC1400ARDUINOTOBO1	SP005346544	Board

Product collaterals / Online support
Product page
User manual
XMCTM software for Arduino IDE

650 V high and low current half-bridge SOI gate driver family

Infineon broadens its EiceDRIVER[™] portfolio with the new 2ED218x - high current 650 V, 2.5 A, half-bridge SOI gate driver family and new 2ED210x low current 650 V, 0.7 A, half-bridge SOI gate driver family. Both product families include two package options of DSO-8 and DSO-14.The products come with integrated ultra-fast bootstrap diode, excellent negative VS transient immunity and independent under voltage lockout for high and low side output channels, suitable for MOSFETs and IGBTs.

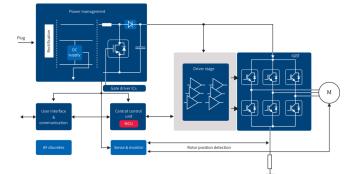
Features

- > Operating voltages (VS node) up to + 650 V
- > Negative VS transient immunity of 100 V
- > Integrated ultra-fast, low resistance bootstrap diode, lowers the BOM cost
- > Shutdown input turns off both channels (selective parts)
- > 200 ns propagation delay
- Separate logic and power ground, shorten the gate loop (DSO-14 package)
- > Independent under voltage lockout (UVLO) for both channels
- > Maximum supply voltage of 25 V

Target applications

- > MHA
- > Industrial drives
- > Motor control and drives
- > Switched mode power supply (SMPS)
- > Uninterruptible power supply (UPS)

Block diagram



Product overview incl. data sheet link

OPN	SP Number	Package
2ED21064S06JXUMA1	SP001710052	PG-DSO-14
2ED2106S06FXUMA1	SP001710050	PG-DSO-8
2ED21084S06JXUMA1	SP003349844	PG-DSO-14
2ED2108S06FXUMA1	SP001710054	PG-DSO-8
2ED21091S06FXUMA1	SP001710060	PG-DSO-8
2ED21094S06JXUMA1	SP003348332	PG-DSO-14
2ED2109S06FXUMA1	SP001710062	PG-DSO-8
2ED21814S06JXUMA1	SP003353682	PG-DSO-14
2ED2181S06FXUMA1	SP001710038	PG-DSO-8
2ED21824S06JXUMA1	SP003244528	PG-DSO-14
2ED2182S06FXUMA1	SP003244532	PG-DSO-8
2ED21834S06JXUMA1	SP003357056	PG-DSO-14
2ED2183S06FXUMA1	SP001710042	PG-DSO-8
2ED21844S06JXUMA1	SP001710048	PG-DSO-14
2ED2184S06FXUMA1	SP001710046	PG-DSO-8



Benefits

- > Integrated bootstrap diode (BSD)- Space saving, reduced BOM cost, smaller PCB at lower cost with simpler design
- > 50% lower level-shift losses with Infineon SOI technology for higher switching frequencies for SMPS and UPS applications
- Excellent ruggedness and noise immunity against negative transient voltages (-100 V) on VS pin
- > No parasitic device structures present in the device, hence no parasitic latch up at all temperature and voltage conditions
- > High current family suitable for high current power device, and high frequency application

Competitive advantage

> Based on Infineon's SOI-technology, having excellent ruggedness and noise immunity against negative transient voltages on VS pin.

Product collaterals / Online support Product family page Gate driver application matrix

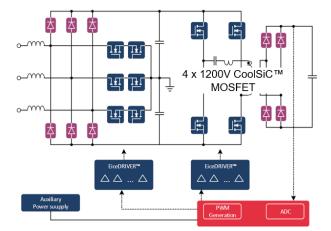
1200 V CoolSiC[™] discrete MOSFETs M1H portfolio extension in TO247-3 and in TO247-4 packages

Infineon is now starting the market introduction for 12 new products CoolSiCTM 1200 V discrete MOSFETs portfolio in TO247 three-pin and four-pin packages. With these products Infineon addresses the fast-growing demand for energy-efficient SiC solutions in power conversion schemes such as battery charging infrastructure, energy storage solutions, photovoltaic inverters, uninterruptable power supplies (UPS), motor drives and industrial powers supplies. The new discrete portfolio is rated from 30 m Ω up to 350 m Ω and fits for 3-phase power systems ranging from about 1 kW to 80 kW.

Features

- > Ultra-low switching losses
- > Threshold-free on state characteristic
- > Wide gate-source voltage range
- > Benchmark gate threshold voltage, V_{gs(th)} = 4.5 V
- > 0 V turn-off gate voltage for easy and simple gate drive
- > Fully controllable dV/dt
- > Robust body diode for hard commutation
- > Temperature independent turn-off switching losses
- > additionally for TO247-4 package device
- > Sense pin for optimized switching performance

Application diagram



Product overview incl. data sheet link

OPN	SP Number	Package
IMW120R030M1HXKSA1	SP001727390	TO-247-3
IMW120R060M1HXKSA1	SP001808368	TO-247-3
IMW120R090M1HXKSA1	SP001946164	TO-247-3
IMW120R140M1HXKSA1	SP001946184	TO-247-3
IMW120R220M1HXKSA1	SP001946188	TO-247-3
IMW120R350M1HXKSA1	SP001808376	TO-247-3
IMZ120R030M1HXKSA1	SP001727394	TO-247-4
IMZ120R060M1HXKSA1	SP001808370	TO-247-4
IMZ120R090M1HXKSA1	SP001946182	TO-247-4
IMZ120R140M1HXKSA1	SP001946186	TO-247-4
IMZ120R220M1HXKSA1	SP001946190	TO-247-4
IMZ120R350M1HXKSA1	SP001808378	TO-247-4

Benefits

- > Efficiency improvement
- > Enabling higher frequency
- > Increased power density
- > Cooling effort reduction
- > Reduction of system complexity and cost

Target applications

- > EV charging
- > Energy storage
- > Power supplies
- > Motor control and drives

Competitive advantage

- > High gate threshold voltage, V_{GS(th)} = 4.5 V
- > 0 V turn-off gate voltage for easy and simple gate drive
- >~ Short circuit capability of 3 μs at gate voltage 15 V.

Product collaterals / Online support Product family page Application note Application brochure



Integrated two-stage PFC + LLC/LCC resonant half-bridge controller for LED drivers in DSO-19 package

ICL5102HV control IC for LED drivers offers a unique one-package solution for lighting applications up to 350 W, supporting LLC/LCC topology. It is particularly designed to deliver best performance of total harmonic distortions (THD) and power factor (PF).

Compared to level-shifter technology, the integrated coreless transformer not only further reduces the loss at high operation frequency, but also enhances the capability of handling huge negative voltage (-600 V on HSGND). Reduce the number of external components to optimize form factor and reduce bill of material (BOM) with the integrated two-stage combination controller (PFC + LLC/LCC) for lighting applications. Simplify your design and scale down time-to-market.



Features

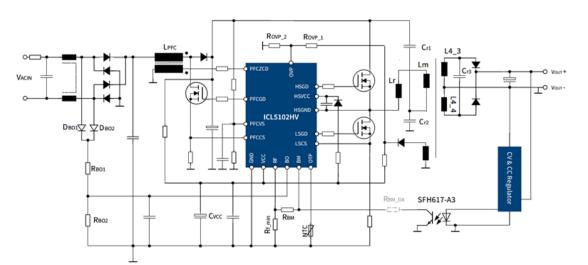
- > Coreless transformer HS drive
- > 480 V_{AC} capable
- Resonant half-bridge (HB) controller with fixed or variable switching frequency control
- Maximum 500 kHz HB switching frequency and soft-start frequency up to 1.3 MHz
- Resonant HB burst mode (BM) ensures power limitation and low standby power <300 mW
- > Excellent system efficiency up to 94%
- > High-side MOSFET driver with coreless transformer
- > Various safety features (protection for input brown-out, PFC bus overvoltage and PFC overcurrent, output overvoltage, output overcurrent/short circuit, output overpower/overload, capacitive mode protection and external over- temperature protection)

Benefits

- > Best THD and PF enable system level optimization
- > Combo IC of PFC + LLC/LCC shortens design to market
- > One IC for global design, reduced variants of products, meaning scale of economy and simplified inventory management

Target applications

- > LED lighting
- > Outdoor lighting
- > Horticulture lighting
- > ACDC applications up to 350 W



Block diagram

Product overview incl. data sheet link

OPN	SP Number	Package
ICL5102HVXUMA1	SP003111046	PG-DSO-19

Product collaterals / Online support

Product page Product brief Application note

CoolSiC[™] MOSFET evaluation board for 7.5 kW motor drive applications

The EVAL-M5-E1B1245N-SiC is a complete evaluation board including a 3phase CoolSiC[™] MOSFET power module for motor drive applications. In combination with one of the available MADK control board options with the M5 32-pin connector, it demonstrates Infineon's silicon carbide power module technology.

It features the EasyPACK[™] 1B 1200 V CoolSiC[™] MOSFET power module FS45MR12W1M1_B11 in sixpack configuration which is optimized for motor drive applications with very high frequency switching operation such as General Purpose Drives and the fast growing servo drive and robotics market.

It is equipped with all assembly groups for sensorless field oriented control (FOC), over-temperature and over-current protection as well as short circuit protection.

The evaluation board was developed to support customers during their first steps designing motor drive applications with FS45MR12W1M1_B11.

Features

- > EasyPACK[™] 1B 1200 V CoolSiC[™] MOSFET power module FS45MR12W1M1_B11 in sixpack configuration
- > Low inductive design
- > PCB size is 259 mm x 204 mm
- > Input voltage 340 480 V_{AC}
- > Overload and short-circuit hardware protection
- > Maximum 7.5 kW motor power output
- > Auxiliary power supply with 5 V

Target applications

> Motor control and drives

Application diagram

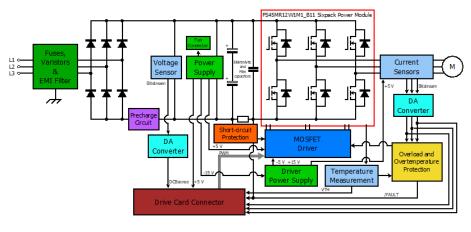


Benefits

- > Support customers during their first steps designing application with the sixpack power module FS45MR12W1M1_B11
- Optimized for motor drive applications with very high frequency switching operation

Competitive advantage

EVAL-M5-E1B1245N-SiC is an evaluation board for motor drive applications comprising the silicon carbide sixpack power module FS45MR12W1M1_B11. Combined in a kit with one of the available MADK control board options, it demonstrates Infineon's silicon carbide power-module technology



Product overview incl. data sheet link

OPN	SP Number	Package
EVALM5E1B1245NSICTOBO1	SP005348966	Board

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OPTIGA™ TRUST M SLS32AIA

The OPTIGA[™] Trust M is a high-end security solution that provides an anchor of trust for connecting IoT devices to the cloud, giving every IoT device its own unique identity. This pre-personalized turnkey solution offers secured, zero-touch onboarding and the high performance needed for quick cloud access.



The turnkey set-up with full system integration minimizes design, integration and deployment effort.

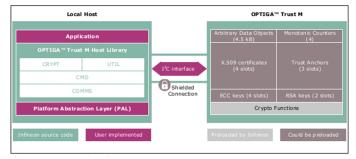
Features

- > High-end security controller with CC EAL6+ (high) certification
- > Turnkey solution: ECC NIST P256/P384, SHA-256, TRNG, DRNG, RSA® 1024/2048
- > Cryptographic toolbox
- > I2C interface with shielded connection
- > Hibernate mode for zero power consumption
- > Up to 10 kB user memory
- > USON-10-2 package (3 x 3 mm)
- > Temperature range up to -40°C to +105°C
- > Software framework on GitHub
- > Device security monitor
- > Lifetime of up to 20 years for industrial and infrastructure applications

Target applications

- > Industrial and building automation
- > Smart home
- > Consumer devices
- > Drones

Block diagram



Product overview incl. data sheet link

OPN	SP Number	Package
SLS32AIA010MHUSON10XTMA2	SP005348666	PG-USON-10
SLS32AIA010MSUSON10XTMA2	SP005348664	PG-USON-10

Benefits

- > Up to 10 times faster cloud connection
- > No secure production environment need at customer premises
- > No PKI handling required at customer premises
- > Secure storage of credentials
- > Easy and cost effective security solution for connected devices.
- > High security with product based on CC certified security controller, and CC certified production site for preprogramming of keys and certificates.

Competitive advantage

- > Open source host code on github
- > Turnkey solution for fast and easy system integration
- > Zero-touch provisioning unique credentials preprogrammed per chip
- > Advanced asymmetric cryptography (ECC & RSA) in a single-chip solution
- > AES128-CCM encrypted communication between the host and the security controller
- Fast and easy access to any cloud provider thanks to prepersonalized certificates

Product collaterals / Online support Product page Product Brief Host code and documentation



OPTIREG™ - TLS850F2TA V50

The OPTIREG[™] linear high performance voltage regulator TLS850F2TA V50 has a TO263 package which guarantees one of the best thermal performances. In addition the complete feature set with Enable, Reset and Watchdog enable this LDO to become an all purpose voltage supply for rough automotive environments up to 500 mA.

DINFINGON OPTIREG "Linear TLSBSOF&TA

Benefits

- > Multi purpose product helps customer to minimize vendor product portfolio
- > Functional safety support -ASIL B
- > Fully applicable for harsh automotive environment
- > Excellent cranking support
- > Less/ smaller external components as required by similar LDO solutions
- > Faster loadstep response, less noise and less external components than switch mode regulators

Target applications

- > Automotive general ECUs
- > Dahsboard and cluster supplies
- > Powertrain and EPS applications
- > Microcontroller supply for safety applications

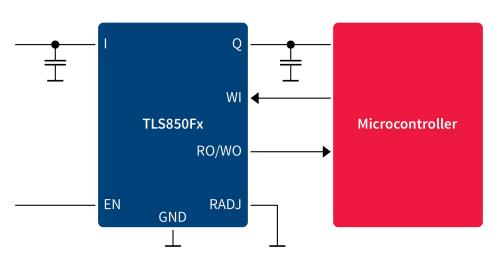
Features

- > Wide input voltage range from 3.0 V to 40 V
- > Fixed output voltage 5 V
- > Output voltage precision $\leq \pm 2$ %
- > Output current capability up to 500 mA
- > Ultra low current consumption typ. 40 μ A
- > Very low dropout voltage typ. 70 mV@100 mA
- > Stable with ceramic output capacitor of 1 μ F
- > Delayed reset at power-on: 16.5 ms
- > Adjustable reset threshold down to 2.50 V
- > Watchdog with fixed timing: 96 m

Competitive advantage

> Very robust, fast load response, best in class Vdrop, high accuracy, digital watchdog and reset timing

Application diagram



Product overview incl. data sheet link

OPN	SP Number	Package
TLS850F2TAV50ATMA1	SP002059374	PG-TO263-7

Product collaterals / Online support Product page Product brief <u>Trainings</u>

OPTIREG™- TLS715B0NA V50

OPTIREG[™] linear TLS715B0NAV50 has the highest automotive package power density available today: up to 1W on a 2x2mm² footprint

TLS715B0NA V50 - OPTIREG[™] Linear Voltage Regulator is a low dropout linear voltage regulator for load current up to 150 mA. An input voltage of up to 40 V is regulated to VQ,nom = 5 V with ±2 % precision. The TLS715B0, with a typical quiescent current of 36 µA, is the ideal solution for systems requiring very low operating current, such as those permanently connected to the battery.



Features

- > Wide input voltage range from 4.0 V to 40 V
- > Output voltage 5 V ±2%
- > Output current up to 150 mA
- > Low current consumption of 36 μ A
- > Low dropout voltage of 180 mV@100 mA
- > Table with small output capacitor of 1µF
- > PSSR typ 60dB (100Hz)
- > Enable

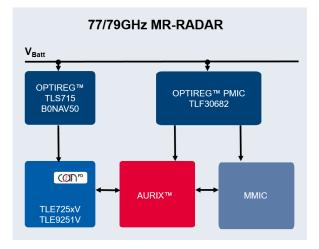
Benefits

- > Tiny food print
- > High power density package,
- > Automotive qualified (AECQ100 grade 1)
- > Leadless
- > Suitable for automated optical inspection

Target applications

- > CAN supply
- > Microcontroller supply, other automotive applications

Application diagram



Product overview incl. data sheet link

OPN	SP Number	Package
TLS715B0NAV50XTSA1	SP001637366	PG-TSNP-7
TLS715B0TSNPBOARDTOBO1	SP001777306	Board

Competitive advantage > Tiny food print with excellent thermal performance package

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